Si9934DY

SEMICONDUCTOR IM

Dual P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

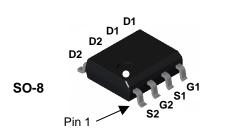
This P-Channel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 12V).

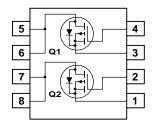
Applications

- Load switch
- Motor drive
- DC/DC conversion
- Power management

Features

- -5 A, -20 V, $R_{DS(ON)} = 50 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 74 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
- Extended V_{GSS} range (±12V) for battery applications
- Low gate charge
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings TA=25°C unless otherwise noted

| Symbol | Parameter | | | Ratings | Units | |
|------------------|---|------------------|-------------|-------------|------------|--|
| V _{DSS} | Drain-Source Voltage | | | -20 | V | |
| V _{GSS} | Gate-Source Voltage | | | ±12 | V | |
| ID | Drain Current – Continuous | | (Note 1a) | -5 | А | |
| | | – Pulsed | | -30 | | |
| P _D | Power Dissipation for Dual Operation | | | 2 | W | |
| | Power Dissipation for Single Operation | | n (Note 1a) | 1.6 | | |
| | | | (Note 1b) | 1 | | |
| | | | (Note 1c) | 0.9 | | |
| T_{J}, T_{STG} | Operating and Storage Junction Temperature Range | | | -55 to +175 | °C | |
| Therma | I Charact | teristics | | | | |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient (Note 1a) | | | 78 | °C/W | |
| R _{θJC} | Thermal Resistance, Junction-to-Case (Note 1) | | | 40 ° | | |
| Packag | e Marking | g and Ordering I | nformation | | | |
| Device Marking | | Device | Reel Size | Tape width | Quantity | |
| 9934 | | Si9934DY | 13" | 12mm | 2500 units | |

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Si9934DY

| teristics rain–Source Breakdown Voltage reakdown Voltage Temperature oefficient ero Gate Voltage Drain Current ate–Body Leakage, Forward | $V_{GS} = 0 \text{ V}, \text{ I}_D = -250 \mu\text{A}$ $I_D = -250 \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$ $V_{DS} = -16 \text{ V}, V_{GS} = 0 \text{ V}$ | -20 | -16 | | V mV/°C |
|---|---|--|--|--|---|
| reakdown Voltage Temperature oefficient ero Gate Voltage Drain Current | $I_D = -250 \ \mu\text{A}$, Referenced to 25°C | -20 | -16 | | - |
| reakdown Voltage Temperature oefficient ero Gate Voltage Drain Current | | | -16 | | m\//ºC |
| | $V_{pc} = -16 V$ $V_{cc} = 0 V$ | | 1 | | 11107 0 |
| ata Bady Laakaga Farward | | | | -1 | μΑ |
| ale-bouy Leakaye, Forwaru | $V_{GS} = -12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$ | | | -100 | nA |
| ate–Body Leakage, Reverse | $V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$ | | | 100 | nA |
| teristics (Note 2) | | | | | |
| ate Threshold Voltage | $V_{\text{DS}} = V_{\text{GS}}, \ I_{\text{D}} = -250 \ \mu\text{A}$ | -0.6 | -1.0 | -1.5 | V |
| ate Threshold Voltage emperature Coefficient | $I_D = -250 \ \mu\text{A}$, Referenced to 25°C | | 3 | | mV/°C |
| tatic Drain–Source n–Resistance | $V_{GS} = -2.5 V$, $I_D = -3 A$ $V_{GS} = -4.5 V$, $I_D = -5$, $T_J = 125^{\circ}C$ | | 36 56 49 | 50 74 80 | mΩ |
| n–State Drain Current | $V_{GS} = -4.5 \text{ V}, \qquad V_{DS} = -5 \text{ V}$ | -15 | | | A |
| orward Transconductance | $V_{\text{DS}} = -5 \text{ V}, \qquad I_{\text{D}} = -5 \text{ A}$ | | 13 | | S |
| haracteristics | | | | | |
| put Capacitance | | | 1015 | 1 | pF |
| utput Capacitance | | | 446 | | pF |
| everse Transfer Capacitance | f = 1.0 MHz | | 118 | 1 | pF |
| Charactaristics (Note 2) | | | 1 | 1 | |
| | $V_{DD} = -5 V.$ $I_D = -1 A,$ | <u> </u> | 11 | 20 | ns |
| urn-On Rise Time | $V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$ | | | - | ns |
| | - | | - | - | ns |
| | - | | - | | ns |
| | $V_{DS} = -5 V$, $I_D = -5 A$, | | • · | | nC |
| | $V_{GS} = -4.5 V$ | | 2.2 | | nC |
| 8 | 4 | | | | nC |
| • | L Marcine Datione | | <u> </u> | | 1.0 |
| | | T | <u> </u> | 13 | <u>م</u> |
| | | | 0.7 | | A |
| oltage | $V_{GS} = 0$ V, $I_S = -1.3$ A (Note 2) | | -0.7 | -1.2 | v |
| | teristics (Note 2) ate Threshold Voltage and Threshold Voltage n-Resistance n-Resistance n-Resistance n-Resistance n-Resistance n-Resistance n-Acteristics put Capacitance utput Capacitance characteristics (Note 2) urn-On Delay Time urn-On Rise Time urn-Off Delay Time urn-Off Fall Time otal Gate Charge ate-Drain Charge rce Diode Characteristics aximum Continuous Drain-Source rain-Source Diode Forward oltage | teristics(Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ Aate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25°Cemperature Coefficient $I_D = -250 \ \mu$ A, Referenced to 25°Cattic Drain–Source $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ n–Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ vGs = -4.5 V, $I_D = -5 \ V$, $V_{DS} = -5 \ V$ n–State Drain Current $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ put Capacitance $V_{DS} = -5 \ V$, $I_D = -5 \ A$ utput Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,terese Transfer Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,um–On Delay Time $V_{DD} = -5 \ V$, $I_D = -1 \ A$,um–On Rise Time $V_{DS} = -4.5 \ V$, $I_D = -1 \ A$,um–Off Delay Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$ um–Off Fall Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$,vGs = -4.5 V $V_{GS} = -4.5 \ V$ ate-Source Charge $V_{GS} = -4.5 \ V$ ate-Drain Charge $V_{GS} = -4.5 \ V$ rce Diode Characteristics and Maximum Ratingsaximum Continuous Drain–Source Diode Forward Currentrain–Source Diode Forward $V_{GS} = 0 \ V$, $I_S = -1.3 \ A$ (Note 2) | teristics (Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ A -0.6 ate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° Cemperature Coefficient $I_D = -250 \ \mu$ A, Referenced to 25° Ctatic Drain–Source $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ n–Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ n–State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ V$ n–State Drain Current $V_{GS} = -4.5 \ V$, $V_{DS} = -5 \ V$ n–State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ m–State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ m–State Drain Current $V_{DS} = -5 \ V$, $I_D = -5 \ A$ m–State Drain Current $V_{DS} = -5 \ V$, $I_D = -5 \ A$ m–State Drain ce $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,tuput Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$,everse Transfer Capacitance $V_{DD} = -5 \ V$, $I_D = -1 \ A$,urn–On Delay Time $V_{DS} = -5 \ V$, $I_D = -1 \ A$,urn–On Rise Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$,urn–Off Delay Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$,urn–Off Fall Time $V_{GS} = -4.5 \ V$ ate–Drain Charge $V_{GS} = -4.5 \ V$ ate–Drain Charge $V_{GS} = 0 \ V$, $I_S = -1.3 \ A$ (Note 2)atimum Continuous Drain–Source Diode Forward Current $I_{S} = -1.3 \ A$ (Note 2)othage $V_{GS} = 0 \ V$, $I_S = -1.3 \ A$ (Note 2) | teristics (Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu$ A, Referenced to 25° C3ate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C3ate Threshold Voltage $I_D = -250 \ \mu$ A, Referenced to 25° C3ate Threshold Voltage $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 36n-Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 56 $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 56 $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 13haracteristics $V_{DS} = -5 \ V$, $I_D = -5 \ A$ 13haracteristics $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -5 \ A$ 1015uput Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -1 \ A$, $I_D = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -10 \ V$, $V_{GS} = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -10 \ V$, $V_{GS} = 0 \ V$, $I_D = -5 \ A$ 118Characteristics (Note 2)urn-On Delay Time $V_{DD} = -5 \ V$, $I_D = -5 \ A$, $I_D = -5 \ A$, $I_D = -10 \ V$, $V_{GS} = -4.5 \ V$, $R_{GEN} = 6 \ \Omega$ 18urn-On Rise Time $V_{DS} = -5 \ V$, $I_D = -5 \ A$, | teristics (Note 2)ate Threshold Voltage $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ -0.6 -1.0 -1.5 ate Threshold Voltage emperature Coefficient $I_D = -250 \ \mu A$, Referenced to 25° C33ate Threshold Voltage emperature Coefficient $I_D = -250 \ \mu A$, Referenced to 25° C336ate Threshold Voltage emperature Coefficient $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 3650n-Resistance $V_{GS} = -4.5 \ V$, $I_D = -5 \ A$ 3650n-State Drain Current $V_{GS} = -4.5 \ V$, $I_D = -5 \ V$ -15 $V_{GS} = -15 \ V$ put Capacitance $V_{DS} = -5 \ V$, $I_D = -5 \ A$ 13 $V_{DS} = -5 \ V$ put Capacitance $V_{DS} = -10 \ V$, $V_{GS} = 0 \ V$, f = $1.0 \ MHz$ $1015 \ V_{446}$ cerese Transfer Capacitance $V_{DS} = -5 \ V$, $I_D = -1 \ A$, $V_{GS} = -4.5 \ V$, $R_{GEN} = 6 \ \Omega$ 1822 $34 \ 555 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \ 0 \$ |

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

Si9934DY Rev A(W)

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